CLAIMS

 A calixresorcinarene compound shown by the following formula (1),

5

wherein R individually represents a hydrogen atom, a
1-tetrahydropyranyl group, a 1-tetrahydrofuranyl group, or one
or more organic groups selected from the group consisting of
the organic groups shown by the following formulas,

wherein n individually represents an integer of 1 to 50,

provided that a compound in which R is selected only from
a hydrogen atom, a 1-tetrahydropyranyl group, and a

1-tetrahydrofuranyl group is excluded.

10

15

25

- 2. A purification method of a calixresorcinarene compound comprising washing the compound according to claim 1 with an acidic aqueous solution and processing the washed compound with an ion-exchange resin.
- 3. A photoresist base material for extreme ultraviolet radiation and/or an electron beam comprising the calixresorcinarene compound shown by the above formula (1).
- 4. A photoresist composition for extreme ultraviolet radiation and/or an electron beam comprising the photoresist base material according to claim 3 and a solvent.
- 5. The photoresist composition according to claim 4, further comprising a photoacid generator.
- 6. The photoresist composition according to claim 4 or 5,20 further comprising a basic organic compound as a quenching agent.
 - 7. A photoresist composition comprising a photoresist base material that is an extreme ultraviolet radiation-reactive organic compound shown by the following formula (2), obtained by washing with an acidic aqueous solution and processing with an ion-exchange resin, a photoacid generator or a photobase

generator, and a quenching agent,

$$\begin{pmatrix}
C
\end{pmatrix}_{m} X$$

$$\begin{pmatrix}
C
\end{pmatrix}_{m} Y$$

5 wherein A is an organic group represented by one of the following formulas,

B, C, and D are individually a group reactive with extreme ultraviolet radiation, a group reactive with an effect of a chromophore active to extreme ultraviolet radiation, or an organic group of any of the following formulas,

$$Ar$$
 Ar CH_2 Ar Ar Ar Ar Ar

wherein Ar is a phenyl group or a naphthyl group substituted with RO- and/or ROCO-, wherein R, RO-, and ROCO- are groups reactive with extreme ultraviolet radiation or groups reactive with an effect of a chromophore active to extreme ultraviolet radiation,

10

. 20

X, Y, and Z individually represent a single bond or an ether bond, and l + m + n = 2, 3, 4, or 8.

- 8. The photoresist composition according to claim 7, wherein the extreme ultraviolet-radiation reactive organic compound is in an amorphous state at room temperature and the average diameter of the molecule is 2 nm or less.
- 9. The photoresist composition according to claim 7, wherein A is an organic group represented by any of the following

formulas,

B, C, and D are individually a hydrogen atom, a tert-butyl group, tert-butyloxycarbonylmethyl group, tert-butyloxycarbonyl group, 1-tetrahydropyranyl group, 1-tetrahydrofuranyl group, 1-ethoxyethyl group, 1-phenoxyethyl group, an organic group shown by the following formula,

$$-\left(\begin{matrix} H_2 \\ C \end{matrix}\right)_S P - \left(\begin{matrix} O \\ II \\ O - C - O - Q \end{matrix}\right)_I$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4 to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, or an organic group represented by any of the following formulas,

$$Ar$$
 Ar CH_2 Ar Ar Ar Ar Ar

wherein Ar is a phenyl group or a naphthyl group substituted with RO- and/or ROCO-, wherein R is a hydrogen atom, a tert-butyl group, tert-butyloxycarbonylmethyl group, tert-butyloxycarbonyl group, 1-tetrahydropyranyl group,

1-phenoxyethyl group, or an organic group shown by the following formula,

1-tetrahydrofuranyl group, 1-ethoxyethyl group,

10

$$-\left(\begin{array}{c} H_2 \\ C \end{array}\right)_S P - \left(\begin{array}{c} O \\ O - C - O - Q \end{array}\right)_{\Gamma}$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4 to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, and

X, Y, and Z individually represent a single bond or an ether bond.

20 10. The photoresist composition according to claim 7, wherein A is any one of the organic groups represented by the following formulas,

- B, C, and D are individually a hydrogen atom, a tert-butyl group, tert-butyloxycarbonylmethyl group,
- tert-butyloxycarbonyl group, 1-tetrahydropyranyl group, 1-tetrahydrofuranyl group, 1-ethoxyethyl group, 1-phenoxyethyl group, or an organic group shown by the following formula,

$$- \left(\begin{array}{c} H_2 \\ C \end{array} \right)_{S} P - \left(\begin{array}{c} O \\ O - C - O - Q \end{array} \right)_{r}$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4 to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, and

X, Y, and Z are ether bonds.

11. A photoresist composition comprising a photoresist base material that is a radiation-reactive organic compound shown by the following formula (2), obtained by washing with an acidic aqueous solution and processing with an ion-exchange resin, a photoacid generator or a photobase generator, and a quenching

agent,

$$\begin{pmatrix}
C
\end{pmatrix}_{m}
\begin{pmatrix}
C
\end{pmatrix}_{m}
\begin{pmatrix}
C
\end{pmatrix}_{n}$$
(2)

wherein A is an organic group represented by one of the following formulas,

B, C, and D are individually a tert-butyloxycarbonylmethyl group, tert-butyloxycarbonyl group, or an organic group shown by the following formula,

$$-\left(\begin{array}{c} H_2 \\ C \end{array}\right)_S P - \left(\begin{array}{c} O \\ O - C - O - Q \end{array}\right)_I$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4

to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, and

X, Y, and Z individually represent a single bond or an ether bond, and l + m + n = 3 or 8.

12. The photoresist composition according to claim 11, wherein the organic group shown by the following formula,

$$-\left(-\frac{H_2}{C}\right)_{S}P - \left(-O - C - O - Q\right)_{r}$$

10

15

is a 4-(tert-butoxycarbonyloxy)benzyl group or a 3,5-di(tert-butoxycarbonyloxy)benzyl group.

- 13. The photoresist composition according to claim 11, wherein the radiation is extreme ultraviolet radiation or an electron beam.
- 14. The photoresist composition according to claim 7 or 11, wherein at least one of B, C, and D is a hydrogen atom and X,20 Y, and Z are ether bonds.
 - 15. The photoresist composition according to claim 7 or 11, wherein the basic impurity content of the photoresist base material is not more than 10 ppm.

25

16. A microfabrication method by lithography using the

photoresist composition according to claim 4, 7, or 11.

17. A semiconductor device prepared using the photoresist composition according to claim 4, 7, or 11.